

**ADDENDUM TO THE BOARD OF REGENTS LOUISIANA MATERIALS DESIGN
ALLIANCE (LAMDA) SEED FUNDING TRACK 4: STEM OUTREACH FY 23-24
REQUEST FOR PROPOSALS**

Due to extensive delays resulting from fiscal year end, the deadline for submission of proposals to the LAMDA Seed Funding Track 4: STEM Outreach has been changed from Friday, July 7, 2023, at 4:30 p.m. Central to **Monday, July 17, 2023, at 4:30 p.m. Central**. All other requirements contained in the RFP remain as previously published. The affected sections of the RFP are cited below, with the revised deadline noted in red.

DEADLINE DATES:

RFP ISSUE DATE: (May 5, 2023)

Last day for questions and answers about this RFP: (June 19, 2023)

Proposals due: (July 17, 2023, 4:30 PM Central Time)

Schedule

Request for Proposals Released	May 5, 2023
Last Day for Q&A	June 19, 2023
Proposals Due	July 17, 2023
Award Notification	August 1, 2023
Project Dates	August 15, 2023 – August 14, 2024

Proposal Submission

The proposal must be submitted by the PI to the Board of Regents through the LA EPSCoR online submission system, <https://laepscor.piestar-rfx.com/opportunities>, no later than the close of business day (4:30 p.m.) on **Monday, July 17, 2023**. All proposals must include a certification letter that the proposal has been approved by the submitting institution's authorized representative, see requirement in the Proposal Format section above.